

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image























High-temperature-resistant pin header.

- touch-safe
- can be plugged into B2CF 3.50 PUSH IN female plug
- Plug-in direction is perpendicular or parallel to the circuit board (180° / 90°)
- Housing variants: closed (G) and with solder flange (LF)
- Box packaging (BX) or, anti-static, tape-on-reel (RL)
- Suitable for reflow and wave soldering applications
- Pin length of either 1.5 mm or 3.5 mm

General ordering data

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 3.50 mm, Number of poles: 22, 180°, Solder pin length (I): 1.5 mm, tinned, black, Box
Order No.	<u>1290510000</u>
Туре	S2C-SMT 3.50/22/180G 1.5SN BK BX
GTIN (EAN)	4050118083279
Qty.	42 pc(s).
Product data	IEC: 200 V / 13.4 A UL: 150 V / 10 A
Packaging	Вох

Creation date September 16, 2022 3:06:57 AM CEST



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Technical data

Dimensions and weights

Depth	10.8 mm	Depth (inches)	0.425 inch
Height	15.7 mm	Height (inches)	0.618 inch
Height of lowest version	14.2 mm	Width	39.9 mm
Width (inches)	1.571 inch	Net weight	8.452 g

System specifications

Product family	OMNIMATE Signal - series B2C/S2C 3.50 - 2-row	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	3.5 mm
Pitch in inches (P)	0.138 inch	Outgoing elbow	180°
Number of poles	22	Number of solder pins per pole	1
Solder pin length (I)	1.5 mm	Solder pin length tolerance	0 / -0.3 mm
Solder pin dimensions	d = 1.0 mm, Octagonal	Solder pin dimensions = d tolerance	+0,01 / -0,03 mm
Solder eyelet hole diameter (D)	1.3 mm	Solder eyelet hole diameter tolerance ([D)+ 0,1 mm
Outside diameter of solder pad	2.1 mm	Template aperture diameter	1.9 mm
L1 in mm	35 mm	L1 in inches	1.378 inch
Number of rows	1	Pin series quantity	2
Touch-safe protection acc. to DIN VDE 57 106	Safe from finger touch	Touch-safe protection acc. to DIN VDE 0470	IP 20
Can be coded	Yes	Plugging force/pole, max.	3.5 N
Pulling force/pole, max.	2.5 N		

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIb
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Copper alloy
Contact surface		Layer structure of solder connection	13 μm Ni / 24 μm Sn
	tinned		matt
Layer structure of plug contact	13 µm Ni / 24 µm Sn	Storage temperature, min.	
	matt		-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-40 °C
Temperature range, installation, max.	120 °C		

Rated data acc. to IEC

	Rated current, min. number of poles	
IEC 60664-1, IEC 61984	(Tu=20°C)	13.4 A
12 A	Rated voltage for surge voltage class / pollution degree II/2	200 V
160 V	Rated voltage for surge voltage class / pollution degree III/3	80 V
2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
2.5 kV	Short-time withstand current resistance	3 x 1s with 80 A
	12 A 160 V 2.5 kV	IEC 60664-1, IEC 61984 (Tu=20°C) Rated voltage for surge voltage class / pollution degree II/2 Rated voltage for surge voltage class / pollution degree III/3 Rated impulse voltage for surge voltage class / pollution degree III/2 Short-time withstand current resistance



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Technical data

Rated data acc. to CSA

Institute (CSA)	€ P-	Certificate No. (CSA)	
	•		200039-1121690
Rated voltage (Use group B / CSA)	150 V	Rated voltage (Use group C / CSA)	50 V
Rated voltage (Use group D / CSA)	150 V	Rated current (Use group B / CSA)	9.5 A
Rated current (Use group C / CSA)	9.5 A	Rated current (Use group D / CSA)	9.5 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		
Packing			
Packaging	Box	VPE length	338 mm
VPE width	130 mm	VPE height	14 mm
Classifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
	27-46-02-01	ECLASS 12.0	27-46-02-01

IPC conformity

Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Notes

- · Gold-plated contact surfaces on request
- Rated current related to rated cross-section & min. No. of poles.
- Spacing between rows: see hole layout
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Long term storage of the product with average temperature of 50 $^{\circ}\text{C}$ and average humidity 70%, 36 months

Approvals

Approvals C C S US US

ROHS	Conform
UL File Number Search	UL Website
Certificate No. (cURus)	E60693



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Technical data

Downloads

Approval/Certificate/Document of	
Conformity	<u>Declaration of the Manufacturer</u>
Engineering Data	CAD data – STEP
Engineering Data	EPLAN, WSCAD
Catalogues	Catalogues in PDF-format
Brochures	FL DRIVES EN
	MB SMT EN
	FL DRIVES DE
	MB DEVICE MANUF. EN
	FL BUILDING SAFETY EN
	FL APPL LED LIGHTING EN
	FL INDUSTR.CONTROLS EN
	FL MACHINE SAFETY EN
	FL HEATING ELECTR EN
	FL APPL_INVERTER EN
	FL_BASE_STATION_EN
	FL ELEVATOR EN
	FL POWER SUPPLY EN
	FL 72H SAMPLE SER EN
	PO OMNIMATE EN
	PO OMNIMATE EN
White paper surface mount technology	Download Whitepaper



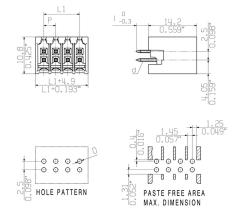
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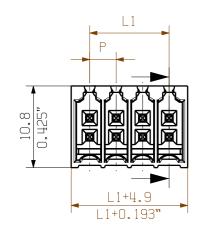
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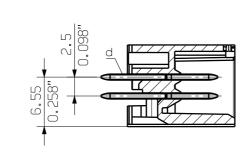
Drawings

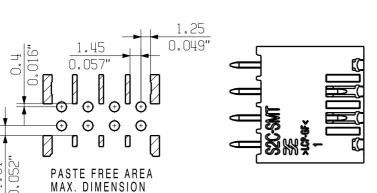
Dimensional drawing

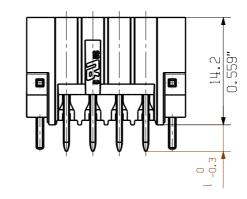


SHOWN: S2C-SMT 3.50/08/180G 3.5

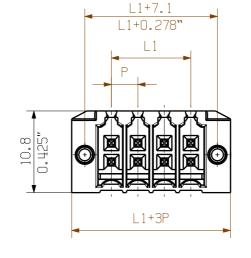


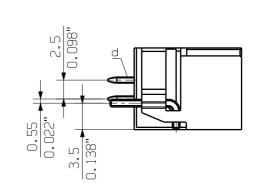


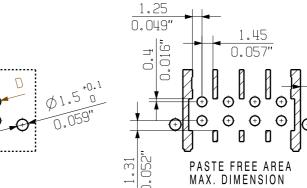




SHOWN: S2C-SMT 3.50/08/180LF 3.5







0.55 HOLE PATTERN

 $D * = { 0.051 \atop 0.051}^{+ 0.1}$

Scale: 2/1

Supersedes:

rated data relates only to the PCB components

For the mounting of PCBs, it should be noted that the

The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110. The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.

36	59.5	2.343	
34	56.0	2.205	
32	52.5	2.067	± 0.2
30	49.0	1.929	
28	45.5	1.791	
26	42.0	1.654	
24	38.5	1.516	+0.15
22	35.0	1.378	± 0.15
20	31.5	1.240	
18	28.0	1.102	
16	24.5	0.965	
16	24.5	0.965	
14	21.0	0.827	
12	17.5	0.689	± 0.1
10	14.0	0.551	
8	10.5	0.413	
6	7.00	0.276	
4	3.50	0.138	
n POLZAHL POLES	L1 [mm]	L1 [inch]	TOLERANZ TOLERANC
	C	at.no.:.	



①

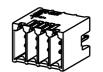
2.5

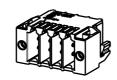
S2C-SMT 3.50/08/180G 3.5

M 1/1S2C-SMT 3.50/08/180LF 1.5

M 1/1 S2C-SMT 3.50/08/180LF 3.5









allgemeingueltige Kundenzeichnung, aktueller Stand nur auf Anfrage general customer drawing, topical version only if required



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	GENERAL TOLERANCE:						
	DIN ISO 2768-m	99681/4 22.03.18 AMANN_A 01					
	Max. nos. Roms				We	eidmüller	
		Modifi	cation				
			Date		Name		
		Drawn	15.07.20	11	FRIELING_L	S	2 C - S
		Responsible			AMANN_A		20-0

04.04.2018 | HELIS_MA

LANG T

PART NAME

Responsible

Checked

Approved

S2C-SMT 3.50...180LF 3.5 | 3.5 | 0.138

1.5 0.059

[mm] | [inch]

S2C-SMT 3.50...180LF 1.5 S2C-SMT 3.50...180G 3.5

S2C-SMT 3.50...180G 1.5

MT 3.50/.../... MALE HEADER

Product file: B2CF/S2C

7400



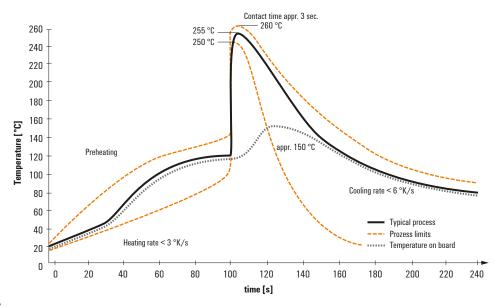
Recommended wave solderding profiles

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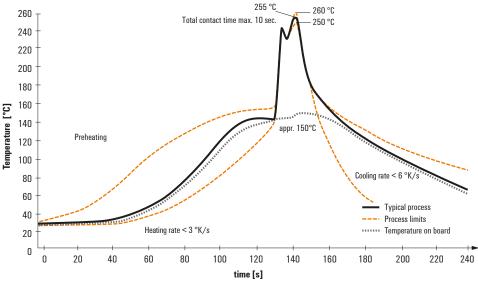
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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

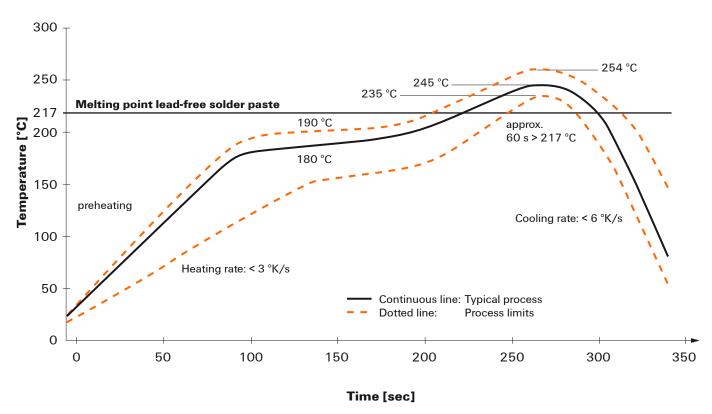


Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.